

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No.: 10/565916 Confirmation No.: 9371
Applicant: CHENG, *et al.*
Filed: 25/JAN/2006
TC/A.U.: 2813
Examiner: S.W. Smoot
Docket No.: DC5157 PCT1
Customer No.: 00137
Date: 21 October 2010
For: Process for Fabricating Electronic Components Using Liquid Injection Molding

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT

Sir:

In response to the office action dated May 24, 2010, please amend the above-identified application as follows. The three-month response date was August 24, 2010. Applicants concurrently submit a request for a two-month extension. Therefore, this response is being timely filed.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 7 of this paper.